

IGBT (NPT) Module

$$V_{CES} = 2 \times 1200 \text{ V}$$

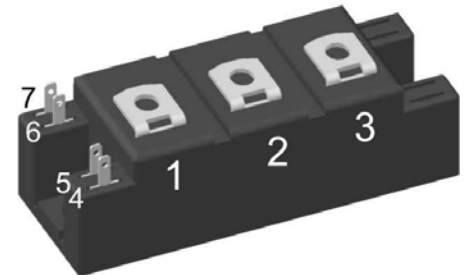
$$I_{C25} = 90 \text{ A}$$

$$V_{CE(sat)} = 2.2 \text{ V}$$

Phase leg

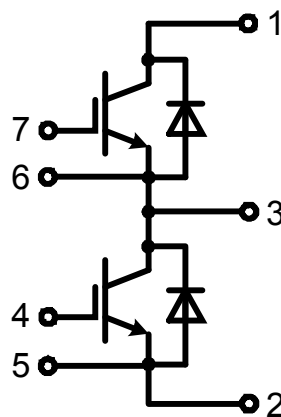
Part number

MII75-12A3



Backside: isolated

 E72873



Features / Advantages:

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes

Applications:

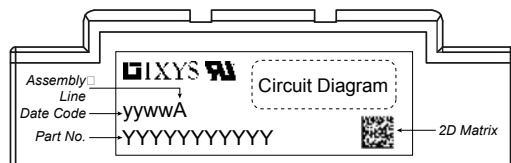
- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

IGBT				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{CES}	collector emitter voltage	T _{VJ} = 25°C				1200	V
V _{GES}	max. DC gate voltage					±20	V
V _{GEM}	max. transient gate emitter voltage					±30	V
I _{C25}	collector current	T _C = 25°C				90	A
I _{C80}		T _C = 80°C				60	A
P _{tot}	total power dissipation	T _C = 25°C				370	W
V _{CE(sat)}	collector emitter saturation voltage	I _C = 50A; V _{GE} = 15 V	T _{VJ} = 25°C T _{VJ} = 125°C		2.2 2.7	2.7	V V
V _{GE(th)}	gate emitter threshold voltage	I _C = 2mA; V _{GE} = V _{CE}	T _{VJ} = 25°C	4.5	5.5	6.5	V
I _{CES}	collector emitter leakage current	V _{CE} = V _{CES} ; V _{GE} = 0 V	T _{VJ} = 25°C T _{VJ} = 125°C			4	mA mA
I _{GES}	gate emitter leakage current	V _{GE} = ±20 V				200	nA
Q _{G(on)}	total gate charge	V _{CE} = 600 V; V _{GE} = 15 V; I _C = 50 A			240		nC
t _{d(on)}	turn-on delay time	inductive load T_{VJ} = 125°C V_{CE} = 600V; I_C = 50A V_{GE} = ±15 V; R_G = 22 Ω			100		ns
t _r	current rise time				70		ns
t _{d(off)}	turn-off delay time				500		ns
t _f	current fall time				70		ns
E _{on}	turn-on energy per pulse				7.6		mJ
E _{off}	turn-off energy per pulse				5.6		mJ
RBSOA	reverse bias safe operating area	V _{GE} = ±15 V; R _G = 22 Ω	T _{VJ} = 125°C				
I _{CM}		V _{CEmax} = 1200V				100	A
SCSOA	short circuit safe operating area	V _{CEmax} = 1200 V					
t _{sc}	short circuit duration	V _{CE} = 1200V; V _{GE} = ±15 V	T _{VJ} = 125°C			10	μs
I _{sc}	short circuit current	R _G = 22 Ω; non-repetitive			180		A
R _{thJC}	thermal resistance junction to case					0.33	K/W
R _{thCH}	thermal resistance case to heatsink				0.33		K/W
Diode							
V _{RRM}	max. repetitive reverse voltage	T _{VJ} = 25°C				1200	V
I _{F25}	forward current	T _C = 25°C				100	A
I _{F80}		T _C = 80°C				60	A
V _F	forward voltage	I _F = 50A	T _{VJ} = 25°C T _{VJ} = 125°C			2.50	V V
I _R	reverse current	V _R = V _{RRM}	T _{VJ} = 25°C T _{VJ} = 125°C			0.65	mA mA
Q _{rr}	reverse recovery charge	V_R = 600 V -di_F/dt = 400 A/μs I_F = 50A; V_{GE} = 0 V			3.5		μC
I _{RM}	max. reverse recovery current				40		A
t _{rr}	reverse recovery time				200		ns
E _{rec}	reverse recovery energy				1		mJ
R _{thJC}	thermal resistance junction to case					0.66	K/W
R _{thCH}	thermal resistance case to heatsink				0.66		K/W

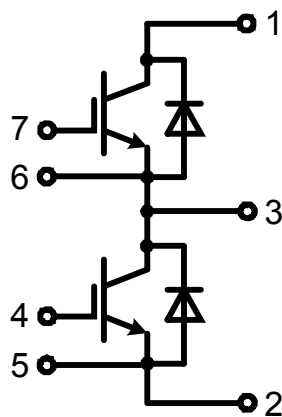
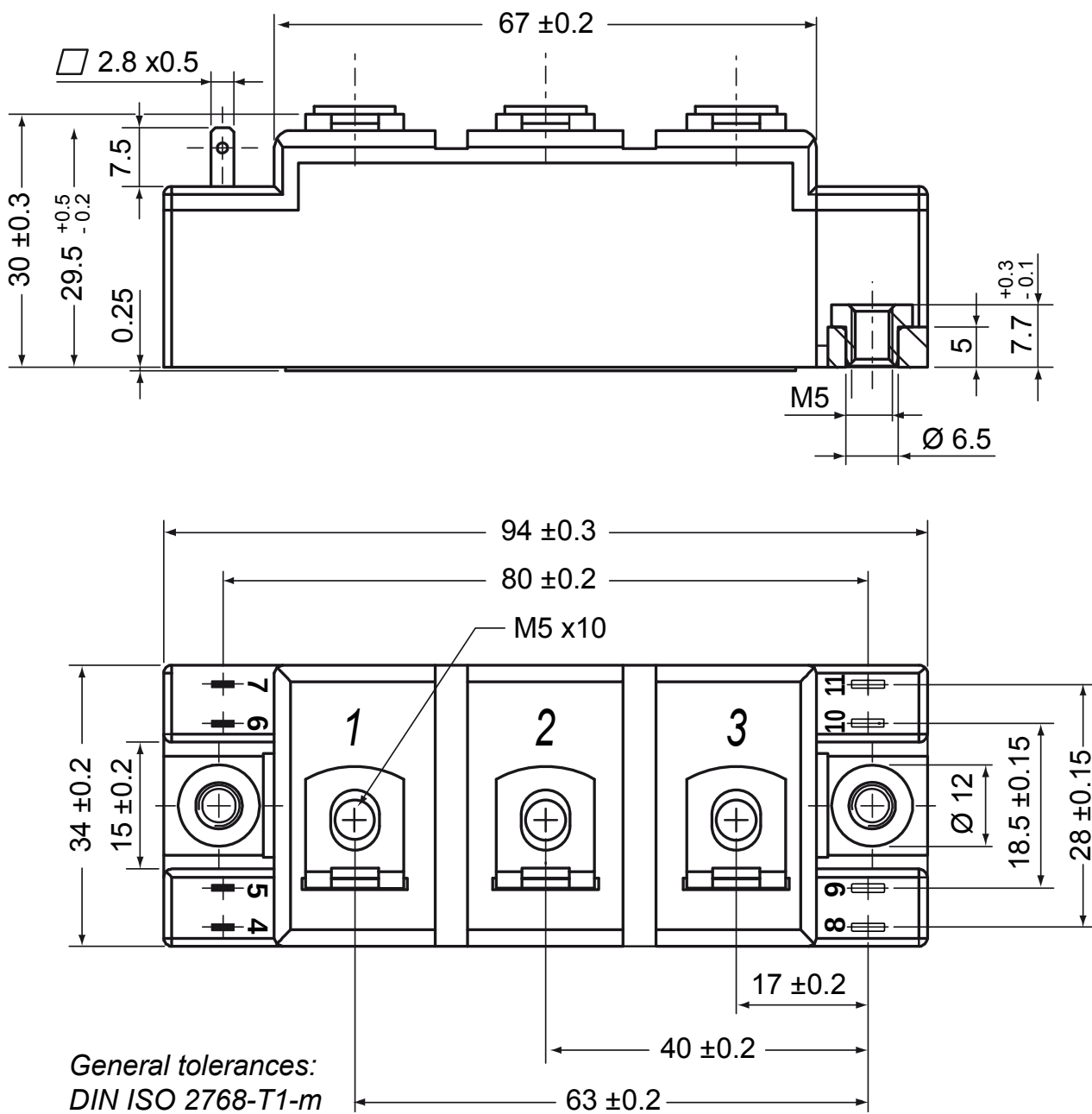
Package Y4				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal				300	A
T_{VJ}	virtual junction temperature			-40		150	°C
T_{op}	operation temperature			-40		125	°C
T_{stg}	storage temperature			-40		125	°C
Weight					110		g
M_D	mounting torque			2.25		2.75	Nm
M_T	terminal torque			4.5		5.5	Nm
$d_{Spp/App}$	creepage distance on surface striking distance through air	terminal to terminal	14.0	10.0			mm
$d_{Spb/Apb}$		terminal to backside	16.0	16.0			mm
V_{ISOL}	isolation voltage	t = 1 second	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3600			V
		t = 1 minute		3000			V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MII75-12A3	MII75-12A3	Box	6	466735

Equivalent Circuits for Simulation		* on die level		$T_{VJ} = 150^\circ\text{C}$	
	$V_{0\max}$	threshold voltage	IGBT	1.5	1.3 V
	$R_{0\max}$	slope resistance *		20.1	10.8 mΩ
			Diode		

Outlines Y4



IGBT

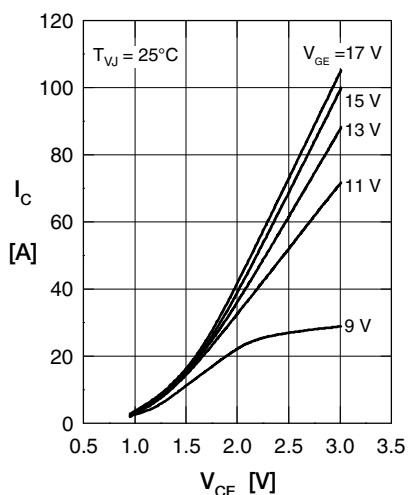


Fig. 1 Typ. output characteristics

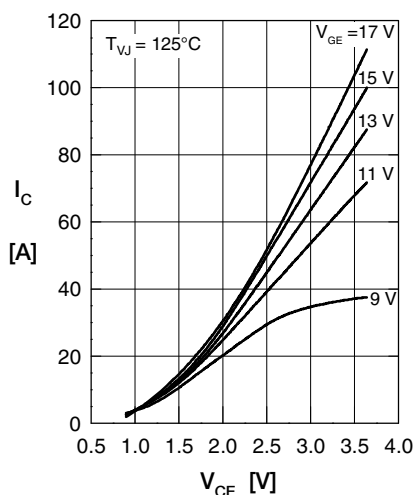


Fig. 2 Typ. output characteristics

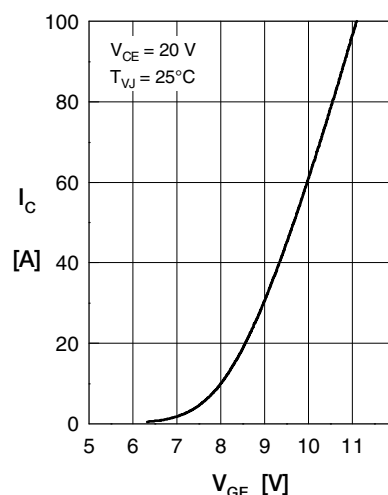


Fig. 3 Typ. transfer characteristics

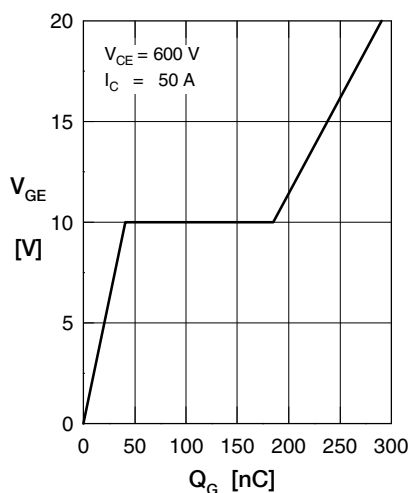


Fig. 4 Typ. turn-on gate charge

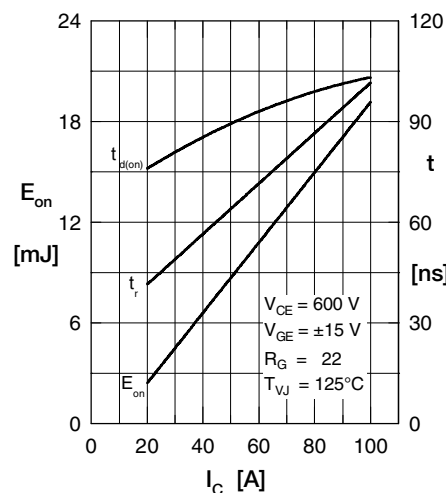


Fig. 5 Typ. turn on energy & switching times versus collector current

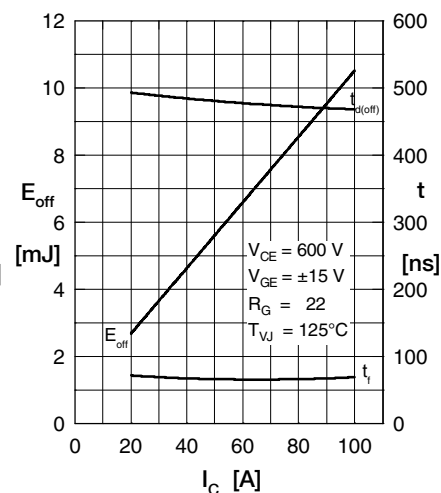


Fig. 6 Typ. turn off energy & switching times versus collector current

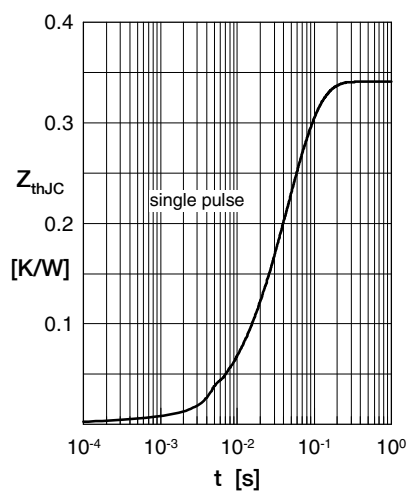


Fig. 12 Typical transient thermal impedance

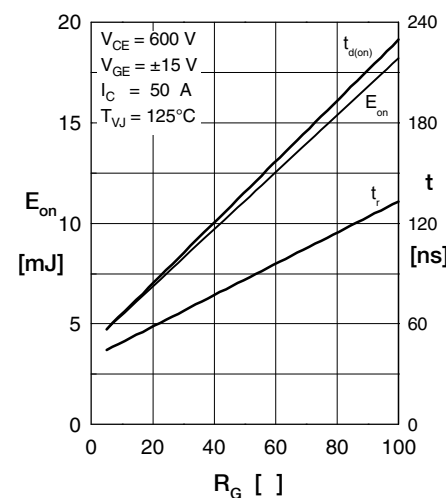


Fig. 9 Typ. turn on energy & switching times versus gate resistor

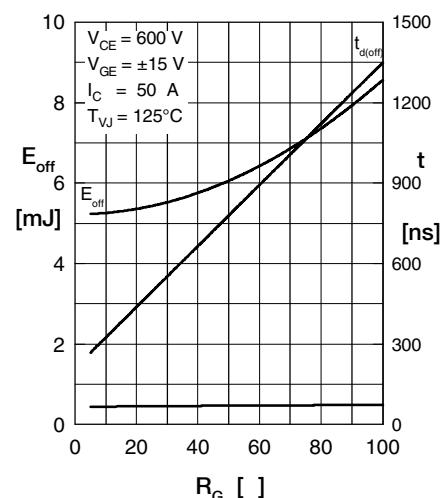


Fig. 9 Typ. turn off energy & switching times versus gate resistor

Diode

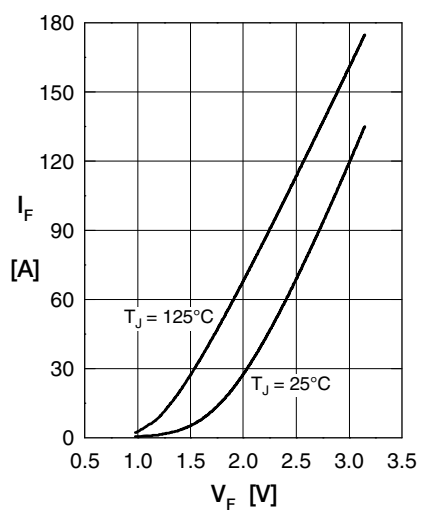
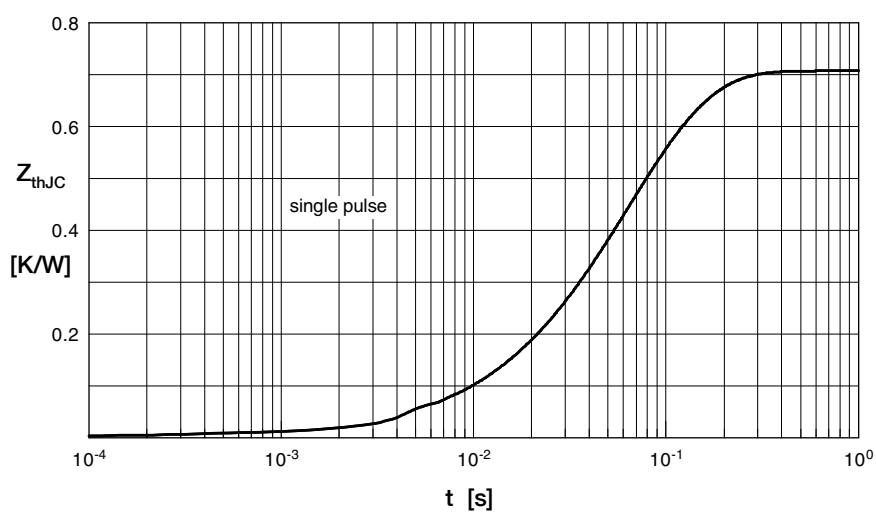
Fig. 1 Typ. Forward current vs. V_F 

Fig. 2 Typ. transient thermal impedance junction to case

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